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#### What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I <sup>2</sup> C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	35
Program Memory Size	28KB (16K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 28x10b; D/A 1x5b, 1x8b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf1719-i-mv

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#### 3.0 MEMORY ORGANIZATION

These devices contain the following types of memory:

- Program Memory
  - Configuration Words
  - Device ID
  - User ID
  - Flash Program Memory
- Data Memory
  - Core Registers
  - Special Function Registers
  - General Purpose RAM
  - Common RAM

Note 1: The method to access Flash memory through the PMCON registers is described in Section 10.0 "Flash Program Memory Control".

The following features are associated with access and control of program memory and data memory:

- PCL and PCLATH
- Stack
- Indirect Addressing

#### TABLE 3-1: DEVICE SIZES AND ADDRESSES

#### 3.1 Program Memory Organization

The enhanced mid-range core has a 15-bit program counter capable of addressing a 32K x 14 program memory space. Table 3-1 shows the memory sizes implemented for the PIC16(L)F1717/8/9 family. Accessing a location above these boundaries will cause a wrap-around within the implemented memory space. The Reset vector is at 0000h and the interrupt vector is at 0004h (see Figure 3-1).

#### 3.2 High-Endurance Flash

This device has a 128-byte section of high-endurance program Flash memory (PFM) in lieu of data EEPROM. This area is especially well suited for nonvolatile data storage that is expected to be updated frequently over the life of the end product. See Section 10.2 "Flash **Program Memory Overview**" for more information on writing data to PFM. See Section 3.2.1.2 "Indirect **Read with FSR**" for more information about using the FSR registers to read byte data stored in PFM.

Device	Program Memory Space (Words)	Last Program Memory Address	High-Endurance Flash Memory Address Range <sup>(1)</sup>
PIC16(L)F1717	8,192	1FFFh	1F80h-1FFFh
PIC16(L)F1718/9	16,384	3FFFh	3F80h-3FFFh

**Note 1:** High-endurance Flash applies to the low byte of each address in the range.

		R/P-1	R/P-1	R/P-1	R/P-1	R/P-1	R/P-1
		LVP <sup>(1)</sup>	DEBUG <sup>(2)</sup>	LPBOR	BORV <sup>(3)</sup>	STVREN	PLLEN
		bit 13					bit 8
R/P-1	U-1	U-1	U-1	U-1	R/P-1	R/P-1	R/P-1
ZCDDIS	_	_	_	_	PPS1WAY	WRT	
bit 7							bit
Legend:							
R = Readable	bit	P = Programm	able bit	U = Unimpleme	ented bit, read as	'1'	
'0' = Bit is clea	ared	'1' = Bit is set		-n = Value wher	n blank or after B	ulk Erase	
bit 13	1 = Low-volta	Itage Programmin ige programming e age on MCLR mus	enabled	gramming			
bit 12	<b>DEBUG:</b> In-C 1 = In-Circuit	Circuit Debugger N Debugger disable Debugger enable	lode bit <sup>(2)</sup> d, ICSPCLK and	ICSPDAT are ge		•	
bit 11	1 = Low-Pow	-Power BOR Enal er Brown-out Rese er Brown-out Rese	et is disabled				
bit 10	1 = Brown-ou	n-out Reset Voltag it Reset voltage (V it Reset voltage (V	BOR), low trip poi				
bit 9	1 = Stack Ove	ack Overflow/Unde erflow or Underflow erflow or Underflow	w will cause a Re	set			
bit 8	<b>PLLEN:</b> PLL 1 = 4xPLL en 0 = 4xPLL dis	abled					
bit 7	<b>ZCDDIS:</b> ZCI 1 = ZCD disa 0 = ZCD alwa	bled. ZCD can be	enabled by settin	ig the ZCDSEN b	bit of ZCDCON		
bit 6-3	Unimplemen	ted: Read as '1'					
bit 2	1 = The PPS future ch	PSLOCK Bit One- LOCK bit can only nanges to PPS reg LOCK bit can be s	y be set once afte gisters are preven	er an unlocking s ted			
bit 1-0	WRT<1:0>: F 8 kW Flash m 11 = Wri 10 = 000 01 = 000 00 = 000 16 kW Flash 11 = Wri 10 = 000 01 = 000	Flash Memory Self <u>hemory (PIC16(L))</u> ite protection off 00h to 01FFh write 00h to 1FFh write <u>memory (PIC16(L</u> ite protection off 00h to 01FFh write 00h to 1FFh write 00h to 3FFh write	-Write Protection -1717) -protected, 02001 -protected, 10001 -protected, no ad <u>)F1718/9)</u> -protected, 02001 -protected, 20001	bits h to 1FFFh may b h to 1FFFh may b ldresses may be h to 3FFFh may b h to 3FFFh may b	be modified by Pl be modified by Pl modified by PMC be modified by Pl be modified by Pl	MCON control MCON control CON control MCON control MCON control	

#### REGISTER 4-2: CONFIG2: CONFIGURATION WORD 2

2: The DEBUG bit in Configuration Words is managed automatically by device development tools including debuggers and programmers. For normal device operation, this bit should be maintained as a '1'.

3: See VBOR parameter for specific trip point voltages.

# 6.0 OSCILLATOR MODULE (WITH FAIL-SAFE CLOCK MONITOR)

#### 6.1 Overview

The oscillator module has a wide variety of clock sources and selection features that allow it to be used in a wide range of applications while maximizing performance and minimizing power consumption. Figure 6-1 illustrates a block diagram of the oscillator module.

Clock sources can be supplied from external oscillators, quartz crystal resonators, ceramic resonators and Resistor-Capacitor (RC) circuits. In addition, the system clock source can be supplied from one of two internal oscillators and PLL circuits, with a choice of speeds selectable via software. Additional clock features include:

- Selectable system clock source between external or internal sources via software
- Two-Speed Start-up mode, which minimizes latency between external oscillator start-up and code execution
- Fail-Safe Clock Monitor (FSCM) designed to detect a failure of the external clock source (LP, XT, HS, ECH, ECM, ECL or EXTRC modes) and switch automatically to the internal oscillator
- Oscillator Start-up Timer (OST), which ensures stability of crystal oscillator sources

The oscillator module can be configured in one of the following clock modes:

- ECL External Clock Low-Power mode (0 MHz to 0.5 MHz)
- 2. ECM External Clock Medium Power mode (0.5 MHz to 4 MHz)
- 3. ECH External Clock High-Power mode (4 MHz to 32 MHz)
- 4. LP 32 kHz Low-Power Crystal mode.
- XT Medium Gain Crystal or Ceramic Resonator Oscillator mode (up to 4 MHz)
- 6. HS High Gain Crystal or Ceramic Resonator mode (4 MHz to 20 MHz)
- 7. EXTRC External Resistor-Capacitor
- 8. INTOSC Internal oscillator (31 kHz to 32 MHz)

Clock Source modes are selected by the FOSC<2:0> bits in the Configuration Words. The FOSC bits determine the type of oscillator that will be used when the device is first powered.

The ECH, ECM, and ECL clock modes rely on an external logic level signal as the device clock source. The LP, XT, and HS clock modes require an external crystal or resonator to be connected to the device.

Each mode is optimized for a different frequency range. The EXTRC clock mode requires an external resistor and capacitor to set the oscillator frequency.

The INTOSC internal oscillator block produces low, medium, and high-frequency clock sources, designated LFINTOSC, MFINTOSC and HFINTOSC. (see Internal Oscillator Block, Figure 6-1). A wide selection of device clock frequencies may be derived from these three clock sources.

#### 6.2 Clock Source Types

Clock sources can be classified as external or internal.

External clock sources rely on external circuitry for the clock source to function. Examples are: oscillator modules (ECH, ECM, ECL mode), quartz crystal resonators or ceramic resonators (LP, XT and HS modes) and Resistor-Capacitor (EXTRC) mode circuits.

Internal clock sources are contained within the oscillator module. The internal oscillator block has two internal oscillators and a dedicated Phase-Lock Loop (HFPLL) that are used to generate three internal system clock sources: the 16 MHz High-Frequency Internal Oscillator (HFINTOSC), 500 kHz (MFINTOSC) and the 31 kHz Low-Frequency Internal Oscillator (LFINTOSC).

The system clock can be selected between external or internal clock sources via the System Clock Select (SCS) bits in the OSCCON register. See **Section 6.3** "**Clock Switching**" for additional information.

#### 6.2.1 EXTERNAL CLOCK SOURCES

An external clock source can be used as the device system clock by performing one of the following actions:

- Program the FOSC<2:0> bits in the Configuration Words to select an external clock source that will be used as the default system clock upon a device Reset.
- Write the SCS<1:0> bits in the OSCCON register to switch the system clock source to:
  - Secondary oscillator during run-time, or
  - An external clock source determined by the value of the FOSC bits.

See **Section 6.3** "Clock Switching" for more information.

#### 6.2.1.1 EC Mode

The External Clock (EC) mode allows an externally generated logic level signal to be the system clock source. When operating in this mode, an external clock source is connected to the OSC1 input. OSC2/CLKOUT is available for general purpose I/O or CLKOUT. Figure 6-2 shows the pin connections for EC mode.

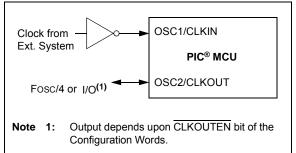
EC mode has three power modes to select from through Configuration Words:

- ECH High power, 4-32 MHz
- ECM Medium power, 0.5-4 MHz
- ECL Low power, 0-0.5 MHz

The Oscillator Start-up Timer (OST) is disabled when EC mode is selected. Therefore, there is no delay in operation after a Power-on Reset (POR) or wake-up from Sleep. Because the PIC<sup>®</sup> MCU design is fully static, stopping the external clock input will have the effect of halting the device while leaving all data intact. Upon restarting the external clock, the device will resume operation as if no time had elapsed.



#### EXTERNAL CLOCK (EC) MODE OPERATION



#### 6.2.1.2 LP, XT, HS Modes

The LP, XT and HS modes support the use of quartz crystal resonators or ceramic resonators connected to OSC1 and OSC2 (see Figure 6-3). The three modes select a low, medium or high gain setting of the internal inverter-amplifier to support various resonator types and speed.

LP Oscillator mode selects the lowest gain setting of the internal inverter-amplifier. LP mode current consumption is the least of the three modes. This mode is designed to drive only 32.768 kHz tuning-fork type crystals (watch crystals).

**XT** Oscillator mode selects the intermediate gain setting of the internal inverter-amplifier. XT mode current consumption is the medium of the three modes. This mode is best suited to drive resonators with a medium drive level specification.

**HS** Oscillator mode selects the highest gain setting of the internal inverter-amplifier. HS mode current consumption is the highest of the three modes. This mode is best suited for resonators that require a high drive setting.

Figure 6-3 and Figure 6-4 show typical circuits for quartz crystal and ceramic resonators, respectively.

#### 6.2.1.4 4x PLL

The oscillator module contains a 4x PLL that can be used with both external and internal clock sources to provide a system clock source. The input frequency for the 4x PLL must fall within specifications. See the PLL Clock Timing Specifications in Table 34-9: PLL Clock Timing Specifications.

The 4x PLL may be enabled for use by one of two methods:

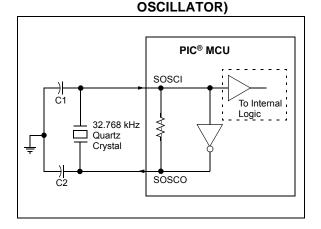
- 1. Program the PLLEN bit in Configuration Words to a '1'.
- Write the SPLLEN bit in the OSCCON register to a '1'. If the PLLEN bit in Configuration Words is programmed to a '1', then the value of SPLLEN is ignored.

#### 6.2.1.5 Secondary Oscillator

The secondary oscillator is a separate crystal oscillator that is associated with the Timer1 peripheral. It is optimized for timekeeping operations with a 32.768 kHz crystal connected between the SOSCO and SOSCI device pins.

The secondary oscillator can be used as an alternate system clock source and can be selected during run-time using clock switching. Refer to **Section 6.3 "Clock Switching"** for more information.

#### FIGURE 6-5: QUARTZ CRYSTAL OPERATION (SECONDARY



- Note 1: Quartz crystal characteristics vary according to type, package and manufacturer. The user should consult the manufacturer data sheets for specifications and recommended application.
  - Always verify oscillator performance over the VDD and temperature range that is expected for the application.
  - **3:** For oscillator design assistance, reference the following Microchip Application Notes:
    - AN826, "Crystal Oscillator Basics and Crystal Selection for rfPIC<sup>®</sup> and PIC<sup>®</sup> Devices" (DS00826)
    - AN849, "Basic PIC<sup>®</sup> Oscillator Design" (DS00849)
    - AN943, "Practical PIC<sup>®</sup> Oscillator Analysis and Design" (DS00943)
    - AN949, "Making Your Oscillator Work" (DS00949)
    - TB097, "Interfacing a Micro Crystal MS1V-T1K 32.768 kHz Tuning Fork Crystal to a PIC16F690/SS" (DS91097)
    - AN1288, "Design Practices for Low-Power External Oscillators" (DS01288)

U-0	U-0	U-0	U-0	R/W-1/1	R/W-1/1	R/W-1/1	R/W-1/1
—	_	_	_	WPUE3	WPUE2 <sup>(3)</sup>	WPUE1 <sup>(3)</sup>	WPUE0 <sup>(3)</sup>
bit 7		·				•	bit 0
Legend:							
R = Readable	bit	W = Writable	bit	U = Unimplei	mented bit, read	as '0'	
u = Bit is unch	anged	x = Bit is unkr	nown	-n/n = Value	at POR and BO	R/Value at all c	ther Resets
'1' = Bit is set		'0' = Bit is clea	ared				

#### **REGISTER 11-37: WPUE: WEAK PULL-UP PORTE REGISTER**<sup>(1,2)</sup>

bit 7-4 Unimplemented: Read as '0'

bit 3-0 WPUE<3:0>: Weak Pull-up Register bits 1 = Pull-up enabled 0 = Pull-up disabled

**Note 1:** Global WPUEN bit of the OPTION\_REG register must be cleared for individual pull-ups to be enabled.

- 2: The weak pull-up device is automatically disabled if the pin is configured as an output.
- 3: PIC16(L)F1717/9 only.

#### REGISTER 11-38: ODCONE: PORTE OPEN-DRAIN CONTROL REGISTER<sup>(1)</sup>

U-0	U-0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
—	—	—	—	_	ODE2	ODE1	ODE0
bit 7							bit 0

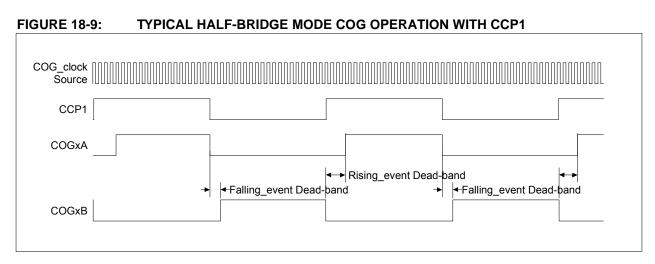
Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-3 Unimplemented: Read as '0'

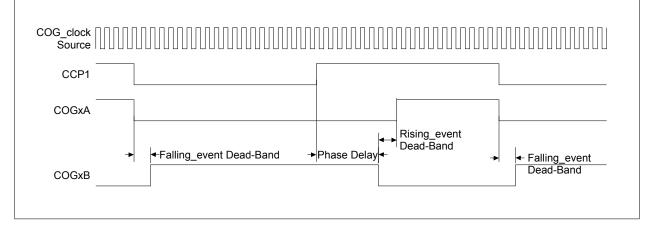
bit 2-0 **ODE<2:0>:** PORTE Open-Drain Enable bits For RE<2:0> pins, respectively 1 = Port pin operates as open-drain drive (sink current only) 0 = Port pin operates as standard push-pull drive (source and sink current)

**Note 1:** PIC16(L)F1717/9 only.

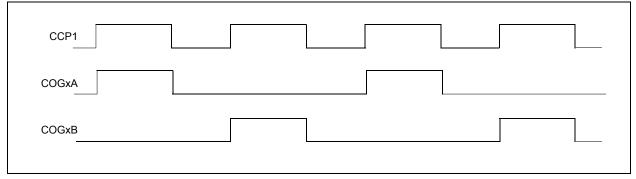
## PIC16(L)F1717/8/9



#### FIGURE 18-10: HALF-BRIDGE MODE COG OPERATION WITH CCP1 AND PHASE DELAY



#### FIGURE 18-11: PUSH-PULL MODE COG OPERATION WITH CCP1



#### REGISTER 18-10: COGxDBR: COG RISING EVENT DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u		
_	_			GxDB	R<5:0>				
bit 7		·					bit 0		
Legend:									
R = Readable	bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'			
u = Bit is uncha	= Bit is unchanged x = I		x = Bit is unknown -n/n = Value at POR and BOR/Value at all other Resets						
'1' = Bit is set		'0' = Bit is clea	ared	g = Value deg	pends on condit	ion			

bit 7-6 Unimplemented: Read as '0' bit 5-0 GxDBR<5:0>: Rising Event Dead-band Count Value bits GxRDBS = 1: = Number of delay chain element periods to delay primary output after rising event GxRDBS = 0: = Number of COGx clock periods to delay primary output after rising event

#### REGISTER 18-11: COGxDBF: COG FALLING EVENT DEAD-BAND COUNT REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
	—			GxDB	F<5:0>		
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

#### bit 7-6 Unimplemented: Read as '0'

bit 5-0 GxDBF<5:0>: Falling Event Dead-band Count Value bits

GxFDBS = 1:

= Number of delay chain element periods to delay complementary output after falling event input GxFDBS = 0:

= Number of COGx clock periods to delay complementary output after falling event input

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELA	_	-	ANSA5	ANSA4	ANSA3	ANSA2	ANSA1	ANSA0	125
ANSELB	_	_	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	131
ANSELC	ANSC7	ANSC6	ANSC5	ANSC4	ANSC3	ANSC2	_	_	136
COG1PHR	_	_			G1PH	R<5:0>			216
COG1PHF	_	_			G1PH	F<5:0>			216
COG1BLKR	_	_			G1BLK	(R<5:0>			215
COG1BLKF	_	_			G1BLK	(F<5:0>			215
COG1DBR		_			G1DB	R<5:0>			214
COG1DBF	_	_		G1DBF<5:0>					
COG1RIS	G1RIS7	G1RIS6	G1RIS5	G1RIS4	G1RIS3	G1RIS2	G1RIS1	G1RIS0	205
COG1RSIM	G1RSIM7	G1RSIM6	G1RSIM5	G1RSIM4	G1RSIM3	G1RSIM2	G1RSIM1	G1RSIM0	206
COG1FIS	G1FIS7	G1FIS6	G1FIS5	G1FIS4	G1FIS3	G1FIS2	G1FIS1	G1FIS0	208
COG1FSIM	G1FSIM7	G1FSIM6	G1FSIM5	G1FSIM4	G1FSIM3	G1FSIM2	G1FSIM1	G1FSIM0	209
COG1CON0	G1EN	G1LD	—	G1CS	6<1:0>		G1MD<2:0>		203
COG1CON1	G1RDBS	G1FDBS		_	G1POLD	G1POLC	G1POLB	G1POLA	204
COG1ASD0	G1ASE	G1ARSEN	G1ASD	BD<1:0>	G1ASD	AC<1:0>	—	—	211
COG1ASD1		_		_	G1AS3E	G1AS2E	G1AS1E	G1AS0E	212
COG1STR	G1SDATD	G1SDATC	G1SDATB	G1SDATA	G1STRD	G1STRC	G1STRB	G1STRA	213
INTCON	GIE	PEIE	T0IE	INTE	IOCIE	TOIF	INTF	IOCIF	90
COG1PPS	_	—	_			COG1PPS<4:0	>		136
PIE2	OSFIE	C2IE	C1IE	—	BCL1IE	TMR6IE	TMR4IE	CCP2IE	92
PIR2	OSFIF	C2IF	C1IF	—	BCL1IF	TMR6IF	TMR4IF	CCP2IF	95
RxyPPS	-	_	_			RxyPPS<4:0>			153

TABLE 18-2: SUMMARY OF REGISTERS ASSOCIATED WITH COG

Legend: x = unknown, u = unchanged, - = unimplemented locations read as '0'. Shaded cells are not used by COG.

#### 20.8 Register Definitions: NCOx Control Registers

			CONTROL	LOISTEN			
R/W-0/0	U-0	R-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
NxEN	—	NxOUT	NxPOL	_	—	—	NxPFM
bit 7							bit 0
Legend:							
R = Readable	e bit	W = Writable	bit	U = Unimpler	nented bit, read	l as '0'	
u = Bit is unch	nanged	x = Bit is unkr	nown	-n/n = Value a	at POR and BO	R/Value at all o	other Resets
'1' = Bit is set		'0' = Bit is cle	ared				
bit 7 bit 6 bit 5 bit 4	0 = NCOx mo	odule is enable odule is disable ted: Read as ' ox Output bit tput is high tput is low	d				
DIT 4	1 = NCOx ou	tput signal is a tput signal is a	•	,			
bit 3-1	Unimplemen	ted: Read as '	0'				
bit 0	1 = NCOx op	Dx Pulse Freque erates in Pulse erates in Fixed	Frequency mo	ode			

#### REGISTER 20-1: NCOxCON: NCOx CONTROL REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0
	NxPWS<2:0>(	1, 2)	—	—	—	NxCKS<1:0>	
bit 7							bit C
Legend:							
R = Readab	le bit	W = Writable b	oit	U = Unimplem	ented bit, read	d as '0'	
u = Bit is un	changed	x = Bit is unkn	own	-n/n = Value a	t POR and BO	R/Value at all o	other Resets
'1' = Bit is se	et	'0' = Bit is clea	red				
	100 = 16 NC 011 = 8 NC 010 = 4 NC 001 = 2 NC 000 = 1 NC	COx clock periods COx clock periods COx clock periods Ox clock periods Ox clock periods Ox clock periods	3				
bit 4-2	-	nted: Read as '0					
bit 1-0	11 = Reser 10 = LC3_c 01 = Fosc		Source Selec	ct bits			

#### REGISTER 20-2: NCOxCLK: NCOx INPUT CLOCK CONTROL REGISTER

Note 1: NxPWS applies only when operating in Pulse Frequency mode.

2: If NCOx pulse width is greater than NCO\_overflow period, operation is undeterminate.

#### REGISTER 20-3: NCOxACCL: NCOx ACCUMULATOR REGISTER – LOW BYTE

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
			NCOXA	\CC<7:0>			
bit 7							bit 0
Legend:							
R = Readable	bit	W = Writable b	oit	U = Unimplen	nented bit, read	d as '0'	
u = Bit is unch	nanged	x = Bit is unkn	own	-n/n = Value a	t POR and BO	R/Value at all o	other Resets
'1' = Bit is set		'0' = Bit is clea	ared				

bit 7-0 NCOxACC<7:0>: NCOx Accumulator, Low Byte

#### 28.5 Register Definitions: Timer2 Control

#### REGISTER 28-1: T2CON: TIMER2 CONTROL REGISTER

U-0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
_		T2OUTF	PS<3:0>		TMR2ON	T2CKF	°S<1:0>
bit 7	·						bit
<b>Legend:</b> R = Readab	le hit	W = Writable	hit	II = I Inimplei	mented bit, read	as '0'	
u = Bit is un		x = Bit is unkr		-	at POR and BO		othor Docote
	•	0' = Bit is clear		at FOR and BO	N value at all		
'1' = Bit is s	el	0 = Bit is clea	ared				
bit 7	Unimpleme	nted: Read as '	0'				
bit 6-3	T2OUTPS<	3:0>: Timer2 Ou	tput Postscale	er Select bits			
	1111 <b>= 1:16</b>	Postscaler					
	1110 <b>= 1:15</b>	Postscaler					
	1101 <b>= 1:14</b>						
	1100 = 1:13						
	1011 = 1:12						
	1010 = 1:11 1001 = 1:10						
	1001 = 1.10 1000 = 1.9 F						
	0111 = 1:8 F						
	0110 = <b>1</b> : <b>7</b> F						
	0101 = 1:6 F	Postscaler					
	0100 = 1:5 F	Postscaler					
	0011 = 1:4 F	Postscaler					
	0010 = 1:3 F						
	0001 = 1:2 F						
<b>L</b> H 0	0000 = 1:1 F						
bit 2	TMR2ON: T						
	1 = Timer2 i 0 = Timer2 i						
bit 1-0	T2CKPS<1:	0>: Timer2 Cloc	k Prescale Se	elect bits			
	11 = Presca	ler is 64					
	10 = Presca	ler is 16					
	01 = Presca	ler is 4					
	00 = Presca						

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#### 29.1.2 TIMER1 MODE RESOURCE

Timer1 must be running in Timer mode or Synchronized Counter mode for the CCP module to use the capture feature. In Asynchronous Counter mode, the capture operation may not work.

See Section 27.0 "Timer1 Module with Gate Control" for more information on configuring Timer1.

#### 29.1.3 SOFTWARE INTERRUPT MODE

When the Capture mode is changed, a false capture interrupt may be generated. The user should keep the CCPxIE interrupt enable bit of the PIEx register clear to avoid false interrupts. Additionally, the user should clear the CCPxIF interrupt flag bit of the PIRx register following any change in Operating mode.

Note:	Clocking Timer1 from the system clock
	(Fosc) should not be used in Capture
	mode. In order for Capture mode to
	recognize the trigger event on the CCPx
	pin, Timer1 must be clocked from the
	instruction clock (Fosc/4) or from an
	external clock source.

#### 29.1.4 CCP PRESCALER

There are four prescaler settings specified by the CCPxM<3:0> bits of the CCPxCON register. Whenever the CCP module is turned off, or the CCP module is not in Capture mode, the prescaler counter is cleared. Any Reset will clear the prescaler counter.

Switching from one capture prescaler to another does not clear the prescaler and may generate a false interrupt. To avoid this unexpected operation, turn the module off by clearing the CCPxCON register before changing the prescaler. Example 29-1 demonstrates the code to perform this function.

#### EXAMPLE 29-1: CHANGING BETWEEN CAPTURE PRESCALERS

BANKSEI	L CCPxCON	;Set Bank bits to point
		;to CCPxCON
CLRF	CCPxCON	;Turn CCP module off
MOVLW	NEW_CAPT_PS	S;Load the W reg with
		;the new prescaler
		;move value and CCP ON
MOVWF	CCPxCON	;Load CCPxCON with this
		;value

#### 29.1.5 CAPTURE DURING SLEEP

Capture mode depends upon the Timer1 module for proper operation. There are two options for driving the Timer1 module in Capture mode. It can be driven by the instruction clock (FOSC/4), or by an external clock source.

When Timer1 is clocked by FOSC/4, Timer1 will not increment during Sleep. When the device wakes from Sleep, Timer1 will continue from its previous state.

Capture mode will operate during Sleep when Timer1 is clocked by an external clock source.

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The 8-bit timer TMR2 register is concatenated with either the 2-bit internal system clock (FOSC), or two bits of the prescaler, to create the 10-bit time base. The system clock is used if the Timer2 prescaler is set to 1:1.

When the 10-bit time base matches the CCPRxH and 2-bit latch, then the CCPx pin is cleared (see Figure 29-4).

#### 29.3.6 PWM RESOLUTION

The resolution determines the number of available duty cycles for a given period. For example, a 10-bit resolution will result in 1024 discrete duty cycles, whereas an 8-bit resolution will result in 256 discrete duty cycles.

The maximum PWM resolution is 10 bits when PR2 is 255. The resolution is a function of the PR2 register value as shown by Equation 29-4.

#### EQUATION 29-4: PWM RESOLUTION

Resolution = 
$$\frac{\log[4(PR2 + 1)]}{\log(2)}$$
 bits

**Note:** If the pulse width value is greater than the period, the assigned PWM pin(s) will remain unchanged.

 TABLE 29-1:
 EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (Fosc = 20 MHz)

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescale	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	6.6

#### TABLE 29-2: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (Fosc = 8 MHz)

PWM Frequency	1.22 kHz	4.90 kHz	19.61 kHz	76.92 kHz	153.85 kHz	200.0 kHz
Timer Prescale	16	4	1	1	1	1
PR2 Value	0x65	0x65	0x65	0x19	0x0C	0x09
Maximum Resolution (bits)	8	8	8	6	5	5

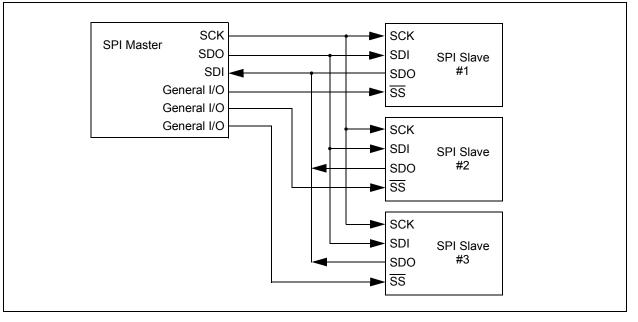
#### 29.3.7 OPERATION IN SLEEP MODE

In Sleep mode, the TMR2 register will not increment and the state of the module will not change. If the CCPx pin is driving a value, it will continue to drive that value. When the device wakes up, TMR2 will continue from its previous state.

#### 29.3.8 CHANGES IN SYSTEM CLOCK FREQUENCY

The PWM frequency is derived from the system clock frequency. Any changes in the system clock frequency will result in changes to the PWM frequency. See Section 6.0 "Oscillator Module (with Fail-Safe Clock Monitor)" for additional details.





#### 30.2.1 SPI MODE REGISTERS

The MSSP module has five registers for SPI mode operation. These are:

- MSSP STATUS register (SSP1STAT)
- MSSP Control register 1 (SSP1CON1)
- MSSP Control register 3 (SSP1CON3)
- MSSP Data Buffer register (SSP1BUF)
- MSSP Address register (SSP1ADD)
- MSSP Shift register (SSP1SR)
- (Not directly accessible)

SSP1CON1 and SSP1STAT are the control and STA-TUS registers in SPI mode operation. The SSP1CON1 register is readable and writable. The lower six bits of the SSP1STAT are read-only. The upper two bits of the SSP1STAT are read/write.

In one SPI master mode, SSP1ADD can be loaded with a value used in the Baud Rate Generator. More information on the Baud Rate Generator is available in **Section 30.7 "Baud Rate Generator"**.

SSP1SR is the shift register used for shifting data in and out. SSP1BUF provides indirect access to the SSP1SR register. SSP1BUF is the buffer register to which data bytes are written, and from which data bytes are read.

In receive operations, SSP1SR and SSP1BUF together create a buffered receiver. When SSP1SR receives a complete byte, it is transferred to SSP1BUF and the SSP1IF interrupt is set.

During transmission, the SSP1BUF is not buffered. A write to SSP1BUF will write to both SSP1BUF and SSP1SR.

#### 30.2.2 SPI MODE OPERATION

When initializing the SPI, several options need to be specified. This is done by programming the appropriate control bits (SSP1CON1<5:0> and SSP1STAT<7:6>). These control bits allow the following to be specified:

- Master mode (SCK is the clock output)
- Slave mode (SCK is the clock input)
- Clock Polarity (Idle state of SCK)
- Data Input Sample Phase (middle or end of data output time)
- Clock Edge (output data on rising/falling edge of SCK)
- Clock Rate (Master mode only)
- · Slave Select mode (Slave mode only)

To enable the serial port, SSP Enable bit, SSPEN of the SSP1CON1 register, must be set. To reset or reconfigure SPI mode, clear the SSPEN bit, re-initialize the SSP1CONx registers and then set the <u>SSPEN</u> bit. This configures the SDI, SDO, SCK and <u>SS</u> pins as serial port pins. For the pins to behave as the serial port function, some must have their data direction bits (in the TRIS register) appropriately programmed as follows:

- · SDI must have corresponding TRIS bit set
- SDO must have corresponding TRIS bit cleared
  SCK (Master mode) must have corresponding
- TRIS bit cleared
- SCK (Slave mode) must have corresponding <u>TRIS</u> bit set
- SS must have corresponding TRIS bit set

Any serial port function that is not desired may be overridden by programming the corresponding data direction (TRIS) register to the opposite value.

#### 31.4.4 BREAK CHARACTER SEQUENCE

The EUSART module has the capability of sending the special Break character sequences that are required by the LIN bus standard. A Break character consists of a Start bit, followed by 12 '0' bits and a Stop bit.

To send a Break character, set the SENDB and TXEN bits of the TX1STA register. The Break character transmission is then initiated by a write to the TX1REG. The value of data written to TX1REG will be ignored and all '0's will be transmitted.

The SENDB bit is automatically reset by hardware after the corresponding Stop bit is sent. This allows the user to preload the transmit FIFO with the next transmit byte following the Break character (typically, the Sync character in the LIN specification).

The TRMT bit of the TX1STA register indicates when the transmit operation is active or idle, just as it does during normal transmission. See Figure 31-9 for the timing of the Break character sequence.

#### 31.4.4.1 Break and Sync Transmit Sequence

The following sequence will start a message frame header made up of a Break, followed by an auto-baud Sync byte. This sequence is typical of a LIN bus master.

- 1. Configure the EUSART for the desired mode.
- 2. Set the TXEN and SENDB bits to enable the Break sequence.
- 3. Load the TX1REG with a dummy character to initiate transmission (the value is ignored).
- 4. Write '55h' to TX1REG to load the Sync character into the transmit FIFO buffer.
- 5. After the Break has been sent, the SENDB bit is reset by hardware and the Sync character is then transmitted.

When the TX1REG becomes empty, as indicated by the TXIF, the next data byte can be written to TX1REG.

#### 31.4.5 RECEIVING A BREAK CHARACTER

The Enhanced EUSART module can receive a Break character in two ways.

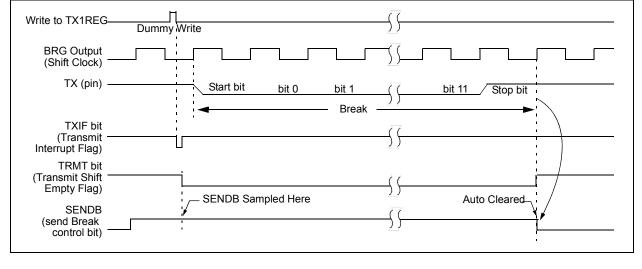
The first method to detect a Break character uses the FERR bit of the RC1STA register and the received data as indicated by RC1REG. The Baud Rate Generator is assumed to have been initialized to the expected baud rate.

A Break character has been received when;

- RCIF bit is set
- FERR bit is set
- RC1REG = 00h

The second method uses the Auto-Wake-up feature described in **Section 31.4.3** "Auto-Wake-up on **Break**". By enabling this feature, the EUSART will sample the next two transitions on RX/DT, cause an RCIF interrupt, and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Detect feature. For both methods, the user can set the ABDEN bit of the BAUD1CON register before placing the EUSART in Sleep mode.



#### FIGURE 31-9: SEND BREAK CHARACTER SEQUENCE

### TABLE 31-7:SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS MASTER<br/>TRANSMISSION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELB	—	—	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	131
ANSELC	ANSC7	ANSC6	ANSC5	ANSC4	ANSC3	ANSC2	—	—	136
BAUD1CON	ABDOVF	RCIDL	_	SCKP	BRG16	_	WUE	ABDEN	362
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	90
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	91
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	94
RC1STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	361
RxyPPS	—	—	—		R	xyPPS<4:0	>		153
SP1BRGL				SP1BR	G<7:0>				363
SP1BRGH				SP1BR0	6<15:8>				363
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	130
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	135
TX1REG			EUSA	RT Transm	nit Data Reg	ister			353*
TX1STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	360

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for synchronous master transmission. \* Page provides register information.

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ANSELB	—	—	ANSB5	ANSB4	ANSB3	ANSB2	ANSB1	ANSB0	131
ANSELC	ANSC7	ANSC6	ANSC5	ANSC4	ANSC3	ANSC2	—	—	136
BAUD1CON	ABDOVF	RCIDL	—	SCKP	BRG16	_	WUE	ABDEN	362
CKPPS	—	—	—		(	CKPPS<4:0	>		152
INTCON	GIE	PEIE	TMR0IE	INTE	IOCIE	TMR0IF	INTF	IOCIF	90
PIE1	TMR1GIE	ADIE	RCIE	TXIE	SSP1IE	CCP1IE	TMR2IE	TMR1IE	91
PIR1	TMR1GIF	ADIF	RCIF	TXIF	SSP1IF	CCP1IF	TMR2IF	TMR1IF	94
RC1STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	361
RxyPPS	—	—	—		F	xyPPS<4:0	>		153
TRISB	TRISB7	TRISB6	TRISB5	TRISB4	TRISB3	TRISB2	TRISB1	TRISB0	130
TRISC	TRISC7	TRISC6	TRISC5	TRISC4	TRISC3	TRISC2	TRISC1	TRISC0	135
TX1REG			EUSA	RT Transm	nit Data Reg	lister			353*
TX1STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	360

### TABLE 31-9:SUMMARY OF REGISTERS ASSOCIATED WITH SYNCHRONOUS SLAVE<br/>TRANSMISSION

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for synchronous slave transmission. \* Page provides register information.

### 31.5.2.3 EUSART Synchronous Slave Reception

The operation of the Synchronous Master and Slave modes is identical (Section 31.5.1.5 "Synchronous Master Reception"), with the following exceptions:

- Sleep
- CREN bit is always set, therefore the receiver is never idle
- SREN bit, which is a "don't care" in Slave mode

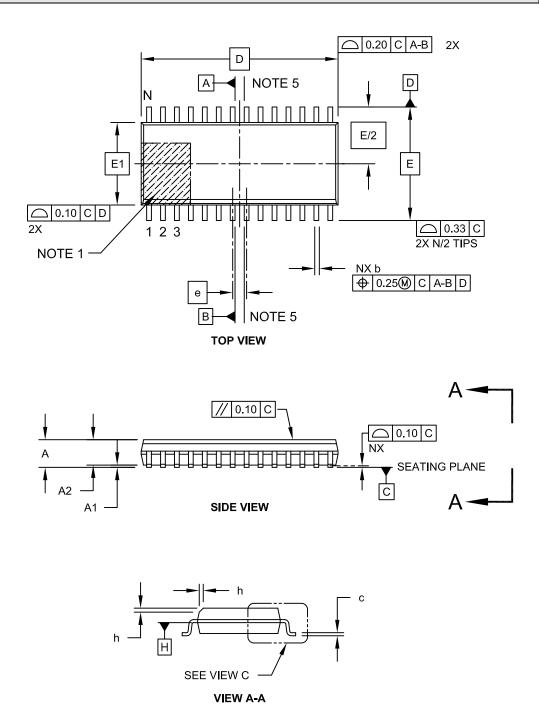
A character may be received while in Sleep mode by setting the CREN bit prior to entering Sleep. Once the word is received, the RSR register will transfer the data to the RC1REG register. If the RCIE enable bit is set, the interrupt generated will wake the device from Sleep and execute the next instruction. If the GIE bit is also set, the program will branch to the interrupt vector.

#### 31.5.2.4 Synchronous Slave Reception Setup

- 1. Set the SYNC and SPEN bits and clear the CSRC bit.
- 2. Clear the ANSEL bit for both the CK and DT pins (if applicable).
- 3. If interrupts are desired, set the RCIE bit of the PIE1 register and the GIE and PEIE bits of the INTCON register.
- 4. If 9-bit reception is desired, set the RX9 bit.
- 5. Set the CREN bit to enable reception.
- The RCIF bit will be set when reception is complete. An interrupt will be generated if the RCIE bit was set.
- 7. If 9-bit mode is enabled, retrieve the Most Significant bit from the RX9D bit of the RC1STA register.
- 8. Retrieve the eight Least Significant bits from the receive FIFO by reading the RC1REG register.
- 9. If an overrun error occurs, clear the error by either clearing the CREN bit of the RC1STA register or by clearing the SPEN bit which resets the EUSART.

#### 28-Lead Plastic Small Outline (SO) - Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



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